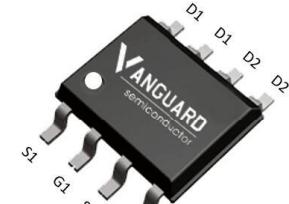


Features

- Dual N-Channel, 5V Logic Level Control
- Enhancement mode
- Low on-resistance $R_{DS(on)}$ @ $V_{GS}=4.5\text{ V}$
- High Effective
- Pb-free lead plating; RoHS compliant

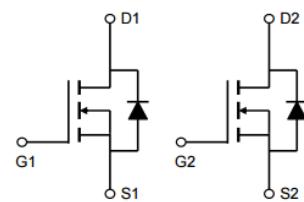
V_{DS}	30	V
$R_{DS(on),TYP} @ V_{GS}=10\text{ V}$	10	$\text{m}\Omega$
$R_{DS(on),TYP} @ V_{GS}=4.5\text{ V}$	14	$\text{m}\Omega$
I_D	12	A

SOP8



HF Halogen-Free

Part ID	Package Type	Marking	Tape and reel information
VS3622DS	SOP8	3622DS	3000pcs/reel



Maximum ratings, at $T_A=25\text{ }^\circ\text{C}$, unless otherwise specified

Symbol	Parameter	Rating	Unit
$V_{(BR)DSS}$	Drain-Source breakdown voltage	30	V
I_s	Diode continuous forward current	$T_A=25\text{ }^\circ\text{C}$	A
I_D	Continuous drain current @ $V_{GS}=10\text{ V}$	$T_A=25\text{ }^\circ\text{C}$	A
		$T_A=100\text{ }^\circ\text{C}$	A
I_{DM}	Pulse drain current tested ①	$T_A=25\text{ }^\circ\text{C}$	A
EAS	Avalanche energy, single pulsed ②	26	mJ
P_D	Maximum power dissipation	$T_A=25\text{ }^\circ\text{C}$	W
V_{GS}	Gate-Source voltage	± 20	V
MSL		Level 3	
T_{STG}, T_J	Storage and junction temperature range	-55 to 150	$^\circ\text{C}$

Thermal Characteristics

Symbol	Parameter	Typical	Unit
R_{eJL}	Thermal Resistance, Junction-to-Lead	40	$^\circ\text{C/W}$
R_{eJA}	Thermal Resistance, Junction-to-Ambient	62.5	$^\circ\text{C/W}$

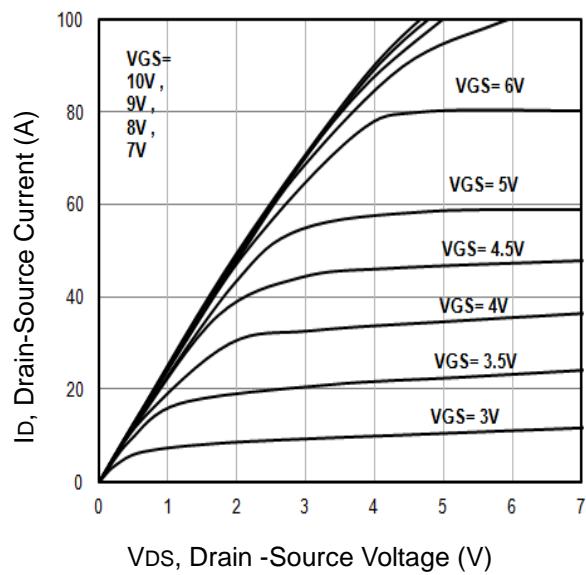
Typical Electrical Characteristics

Symbol	Parameter	Condition	Min.	Typ.	Max.	Unit
Static Electrical Characteristics @ $T_J = 25^\circ\text{C}$ (unless otherwise stated)						
$V_{(\text{BR})\text{DSS}}$	Drain-Source Breakdown Voltage	$V_{\text{GS}}=0\text{V}, I_{\text{D}}=250\mu\text{A}$	30	--	--	V
I_{DSS}	Zero Gate Voltage Drain Current($T_J=25^\circ\text{C}$)	$V_{\text{DS}}=30\text{V}, V_{\text{GS}}=0\text{V}$	--	--	1	μA
	Zero Gate Voltage Drain Current($T_J=125^\circ\text{C}$)	$V_{\text{DS}}=30\text{V}, V_{\text{GS}}=0\text{V}$	--	--	100	μA
I_{GSS}	Gate-Body Leakage Current	$V_{\text{GS}}=\pm 20\text{V}, V_{\text{DS}}=0\text{V}$	--	--	± 100	nA
$V_{\text{GS(TH)}}$	Gate Threshold Voltage	$V_{\text{DS}}=V_{\text{GS}}, I_{\text{D}}=250\mu\text{A}$	1.3	1.7	2.4	V
$R_{\text{DS(ON)}}$	Drain-Source On-State Resistance ③	$V_{\text{GS}}=10\text{V}, I_{\text{D}}=10\text{A}$	--	10	13	$\text{m}\Omega$
$R_{\text{DS(ON)}}$	Drain-Source On-State Resistance ③	$V_{\text{GS}}=4.5\text{V}, I_{\text{D}}=6\text{A}$	--	14	18	$\text{m}\Omega$
Dynamic Electrical Characteristics @ $T_J = 25^\circ\text{C}$ (unless otherwise stated)						
C_{iss}	Input Capacitance	$V_{\text{DS}}=15\text{V}, V_{\text{GS}}=0\text{V}, f=1\text{MHz}$	780	890	1000	pF
C_{oss}	Output Capacitance		80	140	200	pF
C_{rss}	Reverse Transfer Capacitance		50	100	150	pF
R_g	Gate Resistance	$f=1\text{MHz}$	--	4.5	--	Ω
Q_q	Total Gate Charge	$V_{\text{DS}}=15\text{V}, I_{\text{D}}=10\text{A}, V_{\text{GS}}=10\text{V}$	--	17	--	nC
Q_{qs}	Gate-Source Charge		--	3.8	--	nC
Q_{qd}	Gate-Drain Charge		--	4.8	--	nC
Switching Characteristics						
$t_{\text{d(on)}}$	Turn-on Delay Time	$V_{\text{DD}}=15\text{V}, I_{\text{D}}=10\text{A}, R_{\text{G}}=3\Omega, V_{\text{GS}}=10\text{V}$	--	6.5	--	nS
t_r	Turn-on Rise Time		--	11.2	--	nS
$t_{\text{d(off)}}$	Turn-Off Delay Time		--	20.7	--	nS
t_f	Turn-Off Fall Time		--	5.3	--	nS
Source- Drain Diode Characteristics@ $T_J = 25^\circ\text{C}$ (unless otherwise stated)						
V_{SD}	Forward on voltage	$I_{\text{SD}}=2\text{A}, V_{\text{GS}}=0\text{V}$	--	0.8	1.2	V
t_{rr}	Reverse Recovery Time	$T_J=25^\circ\text{C}, I_{\text{SD}}=10\text{A}, V_{\text{GS}}=0\text{V}$ $dI/dt=500\text{A}/\mu\text{s}$	--	20	--	nS
Q_{rr}	Reverse Recovery Charge		--	11.5	--	nC

NOTE:

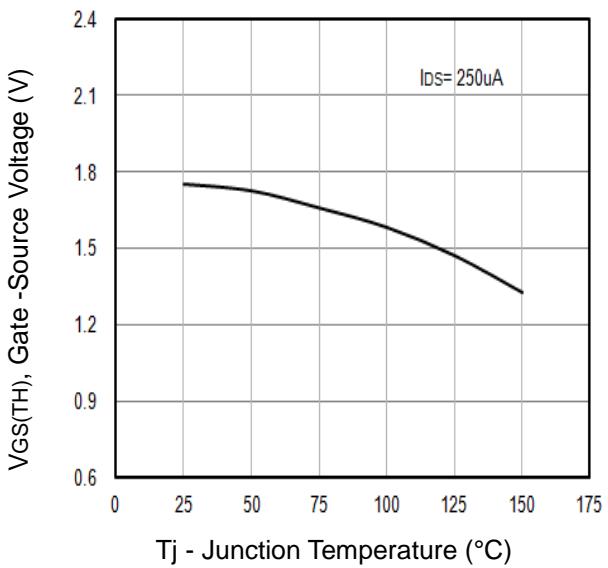
- ① Repetitive rating; pulse width limited by max. junction temperature.
- ② Limited by $T_{J\text{max}}$, starting $T_J = 25^\circ\text{C}$, $L = 0.5\text{mH}$, $R_G = 25\Omega$, $I_{AS} = 8\text{A}$, $V_{GS} = 10\text{V}$. Part not recommended for use above this value
- ③ Pulse width $\leq 300\mu\text{s}$; duty cycle $\leq 2\%$.

Typical Characteristics



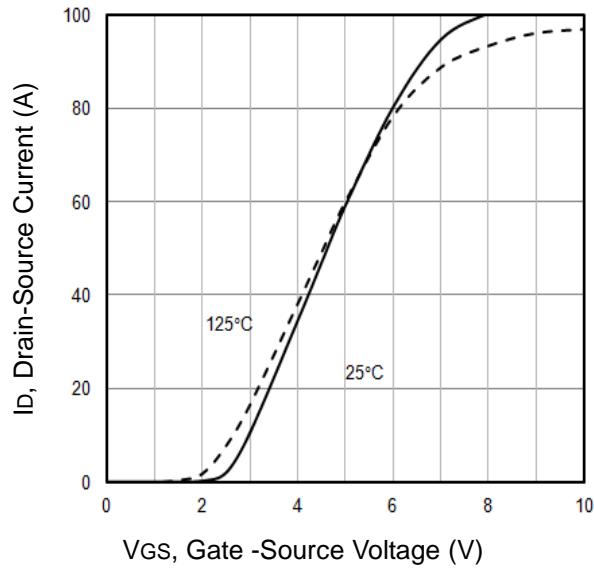
V_{DS}, Drain -Source Voltage (V)

Fig1. Typical Output Characteristics



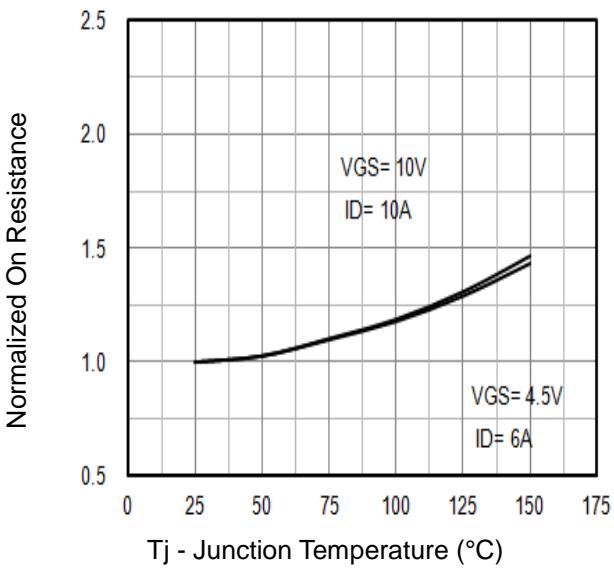
T_j - Junction Temperature (°C)

Fig2. Threshold Voltage Vs. Temperature



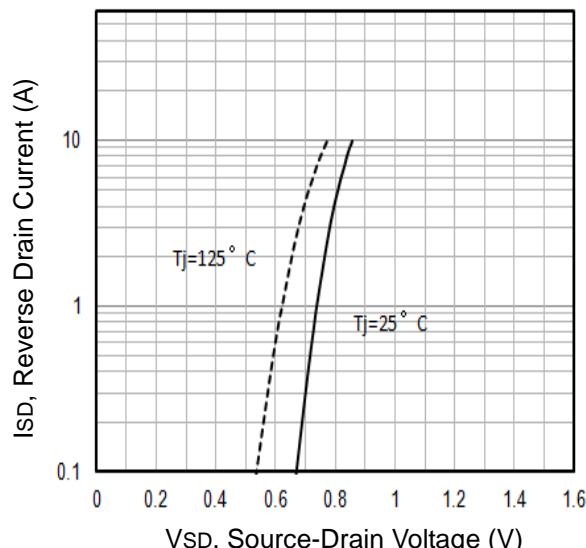
V_{GS}, Gate -Source Voltage (V)

Fig3. Typical Transfer Characteristics



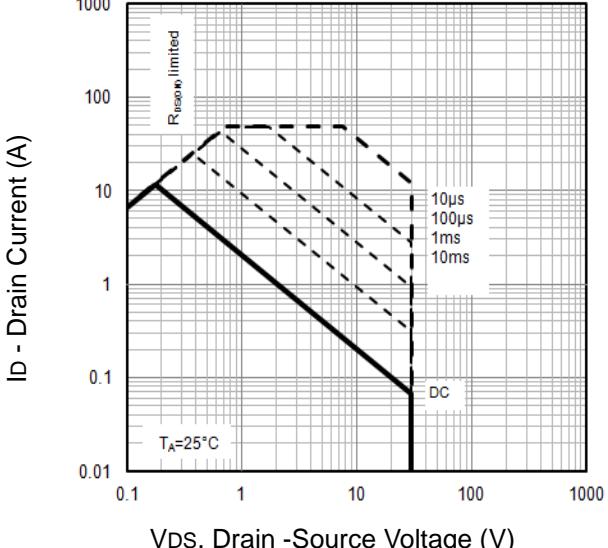
T_j - Junction Temperature (°C)

Fig4. Normalized On-Resistance Vs. Temperature



V_{SD}, Source-Drain Voltage (V)

Fig5. Typical Source-Drain Diode Forward Voltage



V_{DS}, Drain -Source Voltage (V)

Fig6. Maximum Safe Operating Area

Typical Characteristics

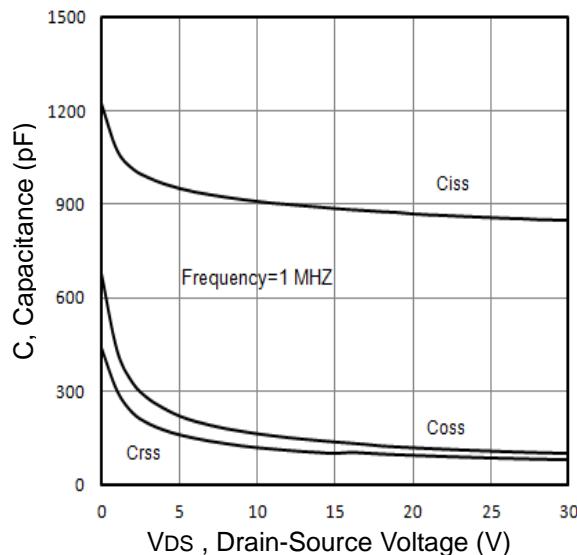


Fig7. Typical Capacitance Vs.Drain-Source Voltage

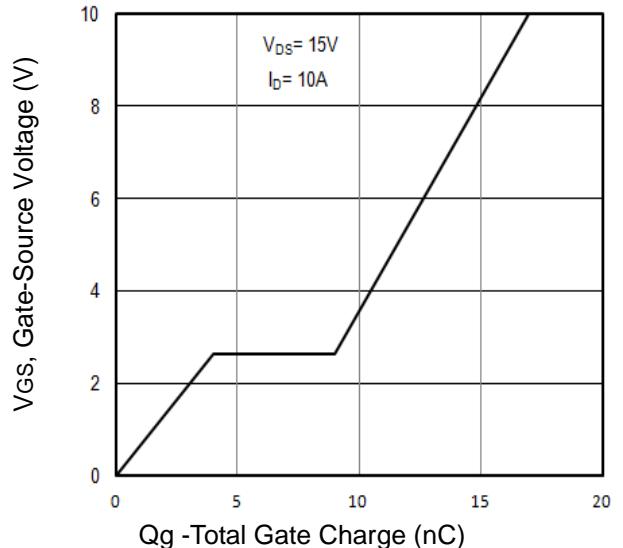
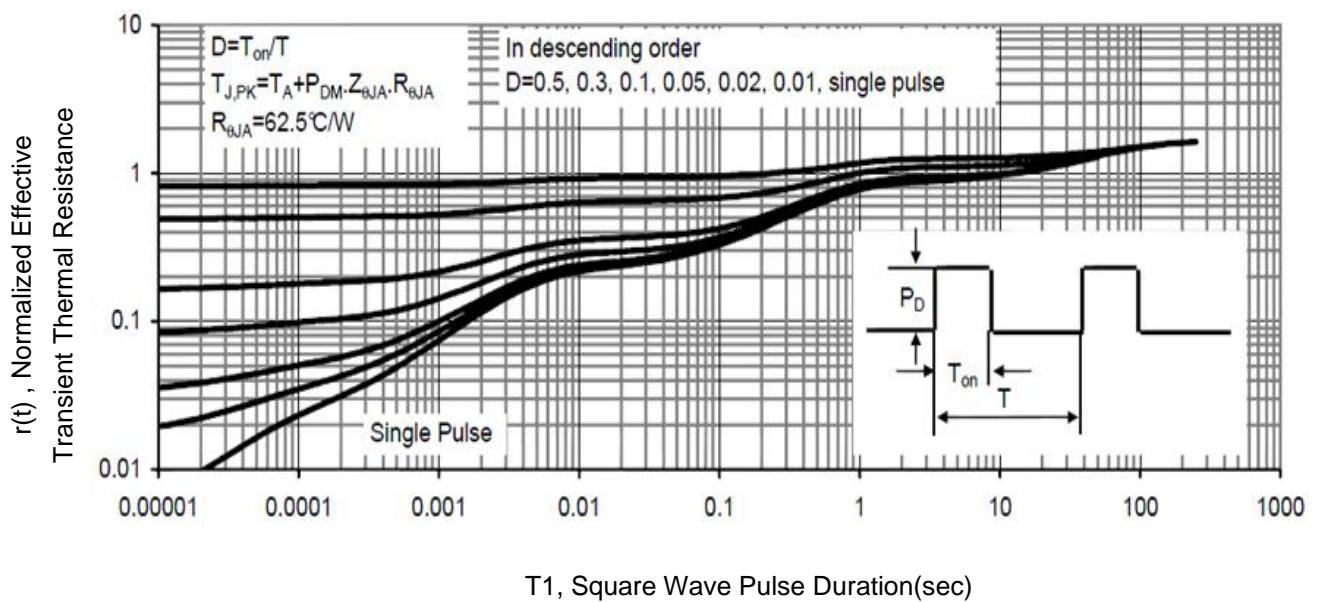


Fig8. Typical Gate Charge Vs.Gate-Source Voltage



T1, Square Wave Pulse Duration(sec)
Fig9. T1 ,Transient Thermal Response Curve

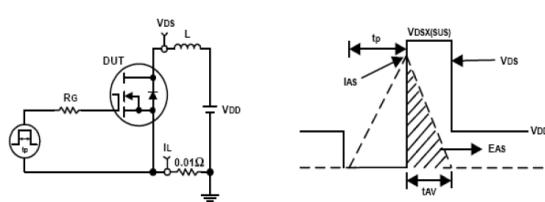


Fig10. Unclamped Inductive Test Circuit and waveforms

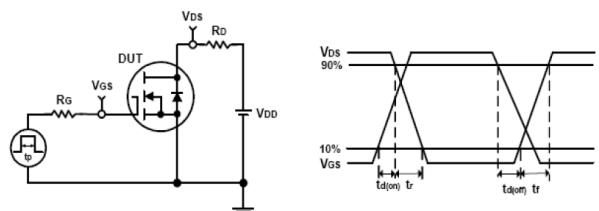
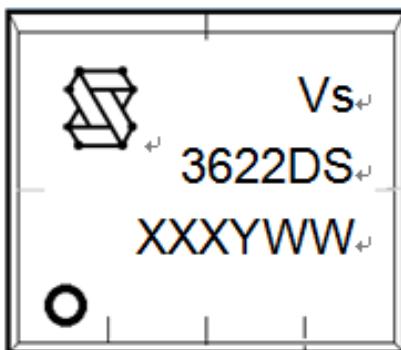


Fig11. Switching Time Test Circuit and waveforms

Marking Information



1st line: Company Code (Vs), Company Logo

2nd line: Part Number (3622DS)

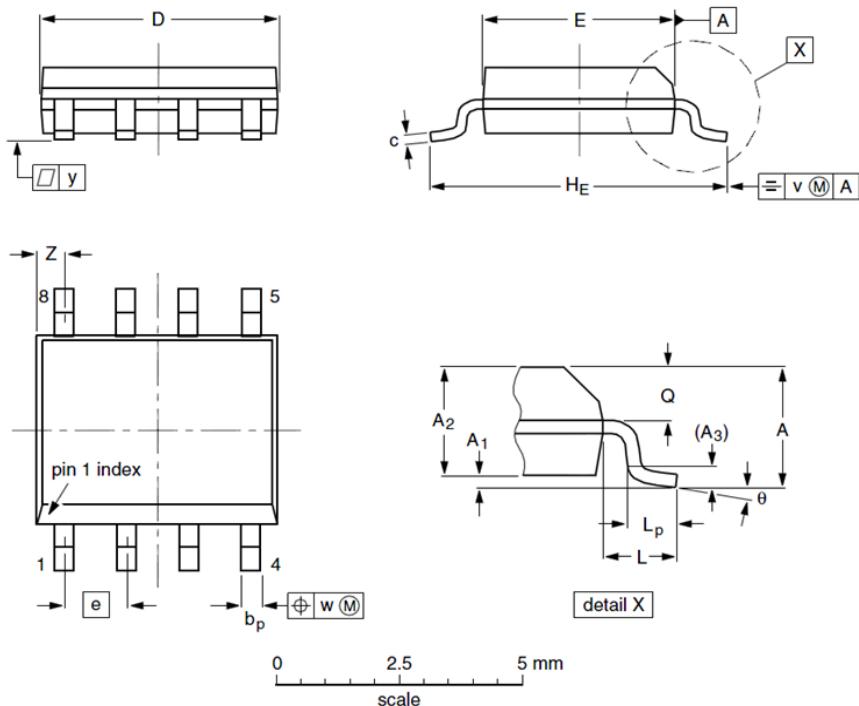
3rd line: Date code (XXXYWW)

XXX: Wafer Lot Number

Y: Year Code, e.g. E means 2017

WW: Week Code

SOP8 Package Outline Data



Label	Dimensions (unit: mm)		
	Min	Typ	Max
A	--	--	1.75
A ₁	0.10	0.18	0.25
A ₂	1.25	1.35	1.50
A ₃	--	0.25	--
b _p	0.36	0.42	0.51
c	0.19	0.22	0.25
D	4.80	4.92	5.00
E	3.80	3.90	4.00
e	--	1.27	--
H _E	5.80	6.00	6.20
L	--	1.05	--
L _p	0.40	0.68	1.00
Q	0.60	0.65	0.725
v	--	0.25	--
w	--	0.25	--
y	--	0.10	--
Z	0.30	0.50	0.70
θ	0°		8°

Notes:

- Follow JEDEC MS-012.
- Dimension "D" does NOT include mold flash, protrusions or gate burrs. Mold flash, protrusions or gate burrs shall not exceed 0.15mm per side.
- Dimension "E" does NOT include interlead flash or protrusion. Interlead flash or protrusion shall not exceed 0.25mm per side.
- Dimension "bp" does NOT include dambar protrusion. Allowable dambar protrusion shall be 0.1mm total in excess of "bp" dimension at maximum material condition. The dambar cannot be located on the lower radius of the foot.

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